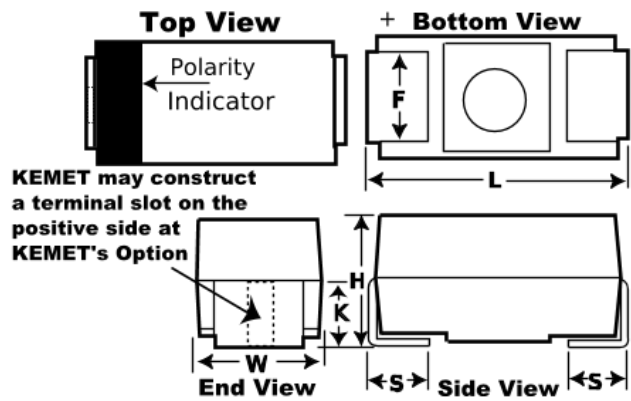




Dimensions	
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.8mm TYP

Packaging Specifications	
Packaging	T&R, 330mm
Packaging Quantity	2800

General Information	
Series	B450
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded, Low ESR, Surge Robust
Features	Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45006D2276M506.

Specifications	
Capacitance	220 uF
Capacitance Tolerance	20%
Voltage DC	6.3 VDC (85C), 4.22 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	10%
Failure Rate	N/A
Resistance	0.05 Ohms (100kHz)
Ripple Current	1730 mAmps (25C), 1557 mAmps (85C), 692 mAmps (125C)
Leakage Current	13.9 uA

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